



PATENT APPLICATION  
Q57317

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Hisashi YAMADA et al.

Appln. No.: 09/462,631

Confirmation No.: Not yet assigned

Group Art Unit: 1762

Filed: January 11, 2000

Examiner: M. PADGETT

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For: GREEN-COMPACT ELECTRODE FOR DISCHARGE SURFACE TREATMENT,  
MANUFACTURING METHOD THEREFOR, METHOD AND APPARATUS FOR  
PERFORMING DISCHARGE SURFACE TREATMENT AND METHOD OF RECYCLING  
GREEN-COMPACT ELECTRODE FOR DISCHARGE SURFACE

AMENDMENT UNDER 37 C.F.R. § 1.111

Commissioner for Patents  
Washington, D.C. 20231

Sir:

This Amendment is submitted in response to the Office Action dated July 23, 2001, in which the Examiner set a three-month period for response.

Please amend the above-identified application as follows:

IN THE SPECIFICATION:

**On page 2, please replace the first full paragraph and the paragraph bridging pages 2 and 3 with the following:**

a/ When the green-compact electrode shown in Fig. 5 is molded, great pressure is generated on the side surfaces of the die 52. Therefore, mold release characteristics required after the molding process are unsatisfactory. Thus, there arises a problem in that the green-compact electrode obtained by compression molding is easily broken. Another problem arises in that the green-compact electrode is too brittle. Therefore, the manufacturing yield of the green-compact electrode excessively deteriorates.